

Statement of Compliance

Requested Part

(Part 1 of 1) 12 June 2023 216562-1

TE Internal Number: 216562-1

Product Description: 4/4 PCB MOD.JACK TE

> Part Status: Active

Mil-Spec Certified: No

EU RoHS Directive 2011/65/EU: Compliant

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: Compliant

2000/53/EC

China RoHS 2 Directive: No Restricted Materials Above Threshold

MIIT Order No 32, 2016

Current ECHA Candidate List: JAN 2023 (233)

EU REACH Regulation: Candidate List Declared Against: JAN 2023 (233) (EC) No. 1907/2006

Does not contain REACH SVHC

Halogen Content: Not Low Halogen - contains Br or CI > 900 ppm.

Solder Process Capability Code: Wave solder capable to 265°C

TE Connectivity Corporation 1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach